Contents STW56N60M2

Contents

1	Electrical ratings	. 3
2	Electrical characteristics	. 4
	2.1 Electrical characteristics (curves)	. 6
3	Test circuits	. 8
4	Package mechanical data	. 9
5	Revision history	11



STW56N60M2 Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{GS}	Gate- source voltage	±25	V
I _D	Drain current (continuous) at T _C = 25 °C	52	Α
I _D	Drain current (continuous) at T _C = 100 °C	33	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	208	Α
P _{TOT}	Total dissipation at T _C = 25 °C	350	W
dv/dt (2)	Peak diode recovery voltage slope	15	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	V/ns
T _{stg}	Storage temperature	- 55 to 150	°C
Tj	Max. operating junction temperature	150	°C

^{1.} Pulse width limited by safe operating area

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-amb}	Thermal resistance junction-ambient max	50	°C/W
R _{thj-case}	Thermal resistance junction-case max	0.36	°C/W

Table 4. Avalanche characteristics

Symbol	Parameter Value		Unit
I _{AR}	Max current during repetitive or single pulse avalanche (pulse width limited by T _{JMAX})	7.5	Α
E _{AS}	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$, $V_{DD} = 50$ V)	1100	mJ

^{2.} $I_{SD} \le 52$ A, di/dt = 400 A/ μ s, peak $V_{DS} < V_{(BR)DSS}$, $V_{DD} = 400$ V

 $^{3. \}quad V_{DS} \leq \ 480 \ V$

Electrical characteristics STW56N60M2

2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Table 5. On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 1 mA, V _{GS} = 0	600			V
I _{DSS}		V _{DS} = 600 V V _{DS} = 600 V, T _C =125 °C			1 100	μA μA
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 25 V			± 10	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	3	4	V
R _{DS(on)}	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, I_D = 26 \text{ A}$		0.045	0.055	Ω

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	3750	-	pF
C _{oss}	Output capacitance	V _{DS} = 100 V, f = 1 MHz,	-	175	-	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0$	-	6.6	-	pF
C _{o(er)} ⁽¹⁾	Equivalent Output Capacitance	$V_{GS} = 0$, $V_{DS} = 0$ to 480V	-	740	-	pF
R_{G}	Intrinsic gate resistance	f = 1 MHz open drain	-	4.7	-	Ω
Qg	Total gate charge	V 400 V 1 50 A	-	91	-	nC
Q _{gs}	Gate-source charge	$V_{DD} = 480 \text{ V}, I_D = 52 \text{ A},$ $V_{GS} = 10 \text{ V}, (see Figure 15)$	-	13.5	-	nC
Q_{gd}	Gate-drain charge	1.GS 1.5 1, (2.50 7 1gano 1.0)	-	41	-	nC

Coss eq. is defined as a constant equivalent capacitance giving the same charging time as Coss when VDS increases from 0 to 80% VDSS

Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 300 \text{ V}, I_{D} = 26 \text{ A},$ $R_{G} = 4.7 \Omega, V_{GS} = 10 \text{ V}$ (see <i>Figure 16</i> and	-	18	-	ns
t _r	Rise time		-	26.5	-	ns
t _{d(off)}	Turn-off delay time		-	119	-	ns
t _f	Fall time	Figure 19)	-	14	-	ns

Table 8. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		52	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		208	Α
V _{SD} (2)	Forward on voltage	$I_{SD} = 52 \text{ A}, V_{GS} = 0$	-		1.6	V
t _{rr}	Reverse recovery time	I _{SD} = 52 A,	-	496		ns
Q _{rr}	Reverse recovery charge	di/dt = 100 A/μs V _{DD} = 100 V (see <i>Figure 16</i>)	-	10		μC
I _{RRM}	Reverse recovery current		-	41		Α
t _{rr}	Reverse recovery time	I _{SD} = 52 A,	-	632		ns
Q _{rr}	Reverse recovery charge	di/dt = 100 A/μs V _{DD} = 60 V, T _i = 150 °C	-	14		μC
I _{RRM}	Reverse recovery current	(see Figure 16)	-	45		Α

^{1.} Pulse width limited by safe operating area

^{2.} Pulsed: pulse duration = $300 \mu s$, duty cycle 1.5%

Electrical characteristics STW56N60M2

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

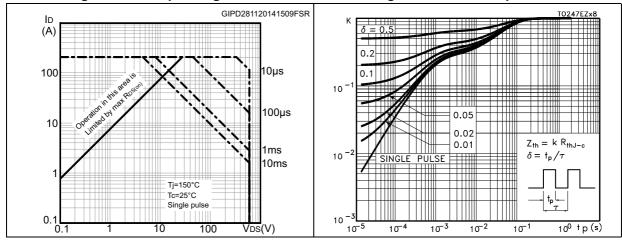


Figure 4. Output characteristics

Figure 5. Transfer characteristics

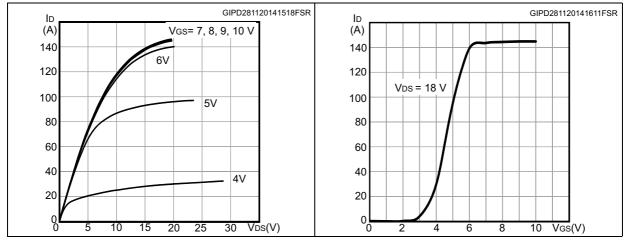
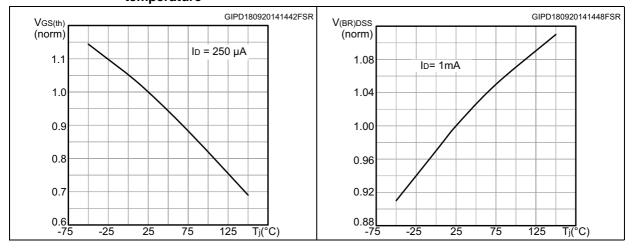


Figure 6. Normalized gate threshold voltage vs. Figure 7. Normalized $V_{(BR)DSS}$ vs. temperature temperature

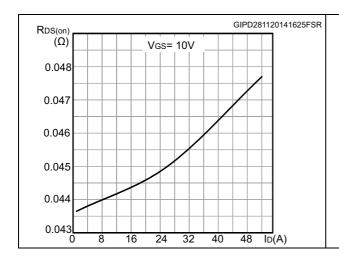


6/12 DocID027243 Rev2



Figure 8. Static drain-source on-resistance

Figure 9. Normalized on-resistance vs. temperature



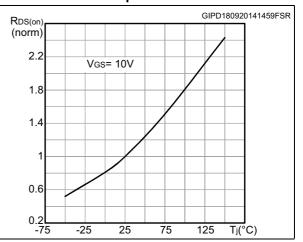
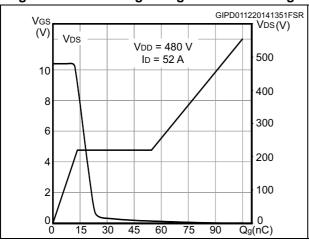


Figure 10. Gate charge vs. gate-source voltage

Figure 11. Capacitance variations



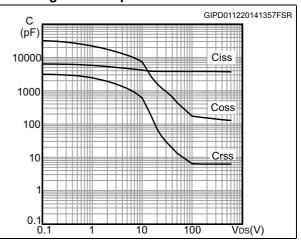
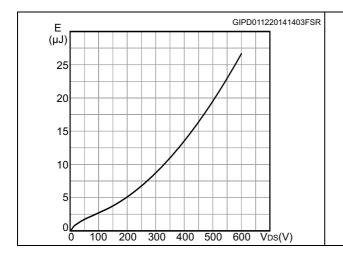
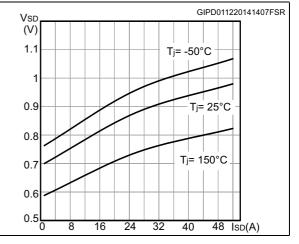


Figure 12. Output capacitance stored energy

Figure 13. Source-drain diode forward characteristics





57/

DocID027243 Rev2

7/12

Test circuits STW56N60M2

3 Test circuits

Figure 14. Switching times test circuit for resistive load

Figure 15. Gate charge test circuit

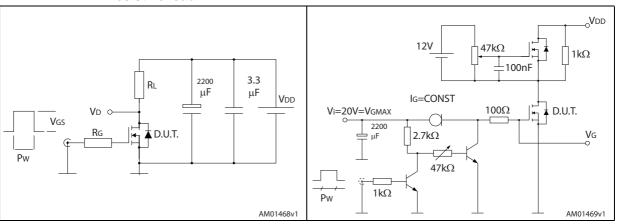


Figure 16. Test circuit for inductive load switching and diode recovery times

Figure 17. Unclamped inductive load test circuit

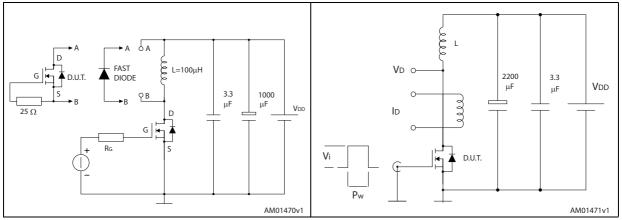
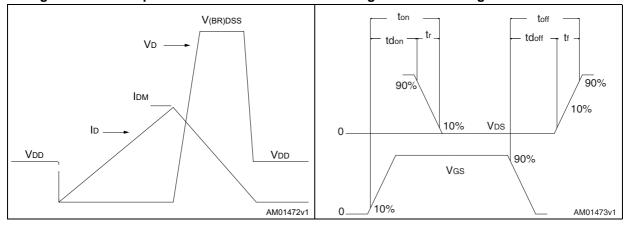


Figure 18. Unclamped inductive waveform

Figure 19. Switching time waveform



8/12 DocID027243 Rev2



4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

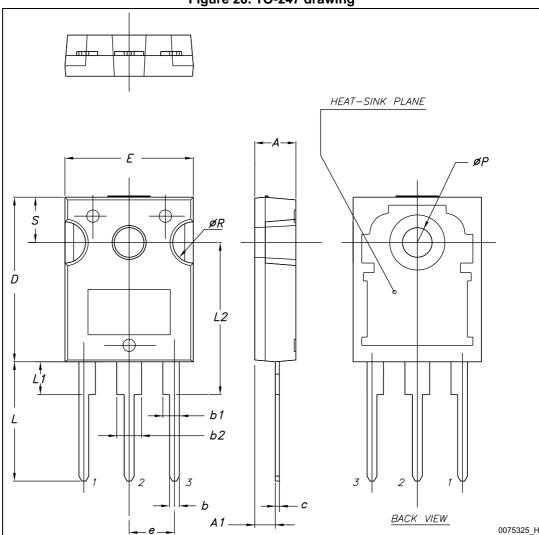


Figure 20. TO-247 drawing

Table 9. TO-247 mechanical data

Dim.		mm.	
Dilli.	Min.	Тур.	Max.
А	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
Е	15.45		15.75
е	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70



STW56N60M2 Revision history

5 Revision history

Table 10. Document revision history

Date	Revision	Changes
01-Dec-2014	1	Initial release.
10-Dec-2014	2	Updated Section 3: Test circuits.

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57

12/12 DocID027243 Rev2